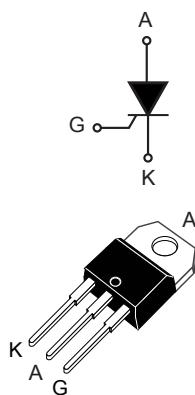


16 A 800 V high temperature SCR thyristor in TO-220AB package


TO-220AB

Features

- High junction temperature: $T_{j\max.} = 150 \text{ }^{\circ}\text{C}$
- $V_{DRM} / V_{RRM} = 800 \text{ V}$
- $V_{DSM} / V_{RSM} = 900 \text{ V}$
- Tight I_{GT} spread: 5 to 8 mA
- High static immunity $dV/dt = 500 \text{ V}/\mu\text{s}$ at $150 \text{ }^{\circ}\text{C}$
- High turn-on rise dl/dt at 100 A/ μs
- Halogen-free molding, lead-free plating
- ECOPACK² compliant

Applications

- Inrush current limiting circuits in AC/DC converters
- General purpose AC line load switching
- Heating resistor control, solid state relays
- Crowbar and power bus discharge circuits

Product status

TN1605H-8T

Product summary

Order code	TN1605H-8T
Package	TO-220AB
$I_T(\text{RMS})$	16 A
V_{DRM}/V_{RRM}	800 V
$T_j \text{ max.}$	150 $^{\circ}\text{C}$

Description

Thanks to its operating junction temperature up to 150°C , the **TN1605H-8T** offers high thermal performance operation up to 16 A rms in a TO-220AB package.

Its trade-off noise immunity ($dV/dt = 500 \text{ V}/\mu\text{s}$) versus its gate triggering current (maximum $I_{GT} = 8 \text{ mA}$) and its turn-on current rise ($dl/dt = 100 \text{ A}/\mu\text{s}$) allows to design robust and compact control circuit in AC/DC converters for inrush current limiting circuits and industrial drives, such as overvoltage crowbar protection, motor control circuits and power tools.

1 Characteristics

Table 1. Absolute maximum ratings (limiting values)

Symbol	Parameter		Value	Unit	
$I_{T(RMS)}$	RMS on-state current (180° conduction angle)	$T_C = 134 \text{ }^\circ\text{C}$	16	A	
$I_{T(AV)}$	Average on-state current (180 ° conduction angle)	$T_C = 134 \text{ }^\circ\text{C}$	10	A	
		$T_C = 139 \text{ }^\circ\text{C}$	8		
		$T_C = 142 \text{ }^\circ\text{C}$	6		
I_{TSM}	Non repetitive surge peak on-state current (T_j initial = 25 °C)	$t_p = 8.3 \text{ ms}$	177	A	
		$t_p = 10 \text{ ms}$	160		
I^2t	I^2t value for fusing	$t_p = 10 \text{ ms}$	128	A^2s	
V_{DRM}, V_{RRM}	Repetitive peak off-state voltage		800	V	
V_{DSM}, V_{RSM}	Non repetitive peak off-state voltage	$t_p = 10 \text{ ms}$	$V_{DRM} / V_{RRM} + 100 \text{ V}$	V	
dI/dt	Critical rate of rise of on-state current $I_G = 2 \times I_{GT}, t_r < 100 \text{ ns}$	$f = 60 \text{ Hz}$	100	$\text{A}/\mu\text{s}$	
I_{GM}	Peak gate current	$t_p = 20 \mu\text{s}$	$T_j = 150 \text{ }^\circ\text{C}$	4	A
$P_{G(AV)}$	Average peak gate power dissipation		$T_j = 150 \text{ }^\circ\text{C}$	1	W
V_{RGM}	Maximum peak reverse gate voltage			5	V
T_{stg}	Storage junction temperature range			-40 to +150	${}^\circ\text{C}$
T_j	Operating junction temperature range			-40 to +150	
T_l	Maximum lead temperature soldering during 10 s			260	

Table 2. Electrical characteristics ($T_j = 25 \text{ }^\circ\text{C}$ unless otherwise specified)

Symbol	Test conditions		Value	Unit	
I_{GT}	$V_D = 12 \text{ V}, R_L = 33 \Omega$	Min.	5	mA	
		Max.	8		
V_{GT}			1.3	V	
V_{GD}	$V_D = V_{DRM}, R_L = 3.3 \text{ k}\Omega$	$T_j = 150 \text{ }^\circ\text{C}$	Min.	0.2	V
I_H	$I_T = 500 \text{ mA, gate open}$		Max.	30	mA
I_L	$I_G = 1.2 \times I_{GT} \text{ max.}$		Max.	40	mA
dV/dt	$V_{OUT} = 536 \text{ V, gate open}$	$T_j = 150 \text{ }^\circ\text{C}$	Min.	500	$\text{V}/\mu\text{s}$
t_{gt}	$I_T = 32 \text{ A, } V_D = 536 \text{ V, } I_G = 12 \text{ mA, } (dI_G/dt) \text{ max} = 0.2 \text{ A}/\mu\text{s}$		Typ.	1.9	μs
t_q	$I_T = 32 \text{ A, } V_D = 536 \text{ V, } V_R = 25 \text{ V, } dV_D/dt = 40 \text{ V}/\mu\text{s}$	$T_j = 25 \text{ }^\circ\text{C}$	Typ.	25	μs
		$T_j = 150 \text{ }^\circ\text{C}$	Typ.	85	μs

Table 3. Static characteristics

Symbol	Test conditions		Value	Unit
V _{TM}	I _{TM} = 32 A, t _p = 380 µs	T _j = 25 °C	Max.	1.55
V _{TO}	Threshold voltage	T _j = 150 °C	Max.	0.82
R _D	Dynamic resistance	T _j = 150 °C	Max.	25 mΩ
I _{DRM} , I _{RRM}	V _D = V _{DRM} ; V _R = V _{RRM}	T _j = 25 °C	Max.	1 µA
		T _j = 150 °C	Max.	3.5 mA

Table 4. Thermal parameters

Symbol	Parameter		Value	Unit
R _{th(j-c)}	Junction to case (DC)	Max.	1.1	°C/W
R _{th(j-a)}	Junction to ambient	Typ.	60	

1.1 Characteristics curves

Figure 1. Maximum average power dissipation versus average on-state current

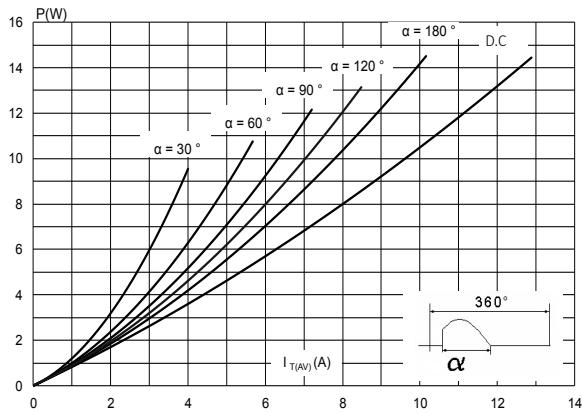


Figure 2. Average and DC on-state current versus case temperature

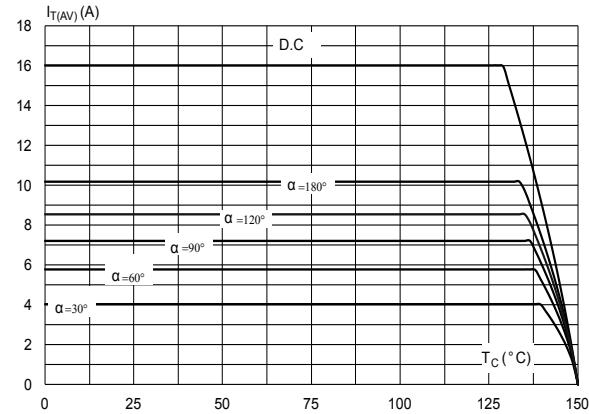


Figure 3. Average and D.C. on-state current versus ambient temperature

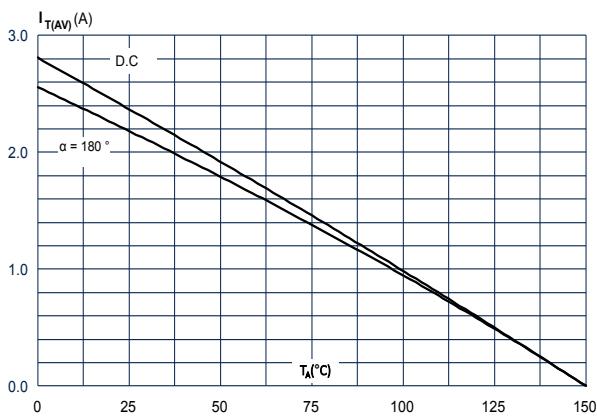


Figure 4. On-state characteristics (maximum values)

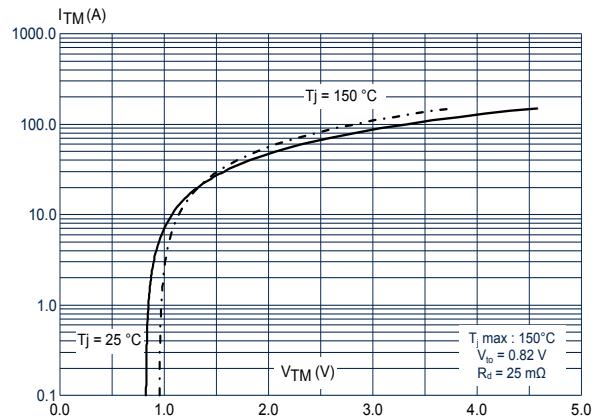


Figure 5. Relative variation of thermal impedance junction to case and junction to ambient versus pulse duration

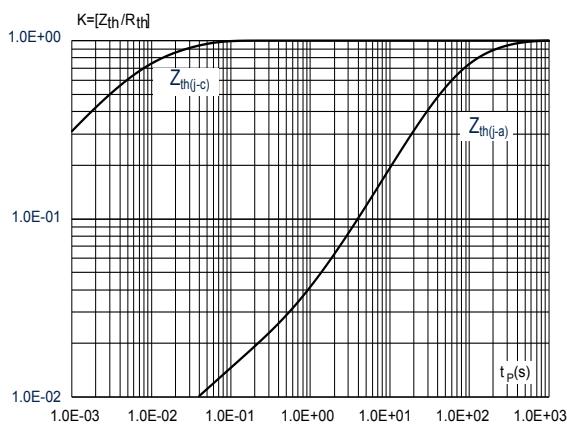


Figure 6. Surge peak on-state current versus number of cycles

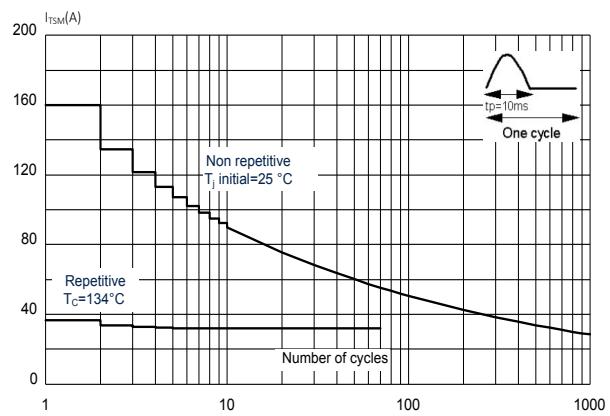


Figure 7. Non repetitive surge peak on-state current for a sinusoidal pulse with width $t_p < 10$ ms

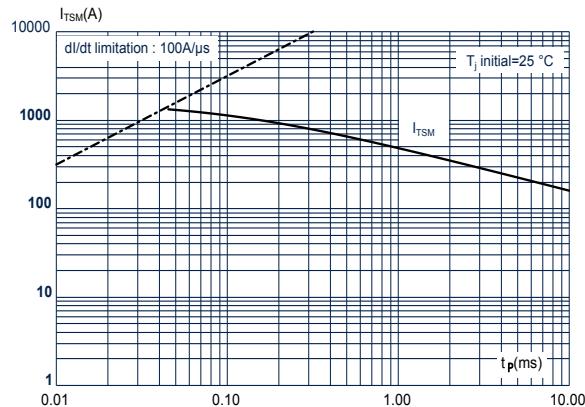


Figure 8. Relative variation of holding current and latching current versus junction temperature (typical values)

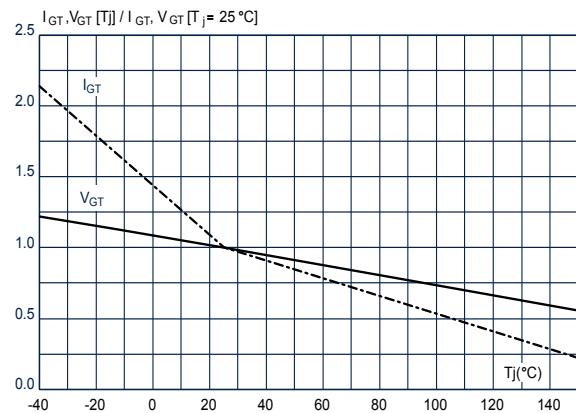


Figure 9. Relative variation of gate triggering current and voltage versus junction temperature (typical values)

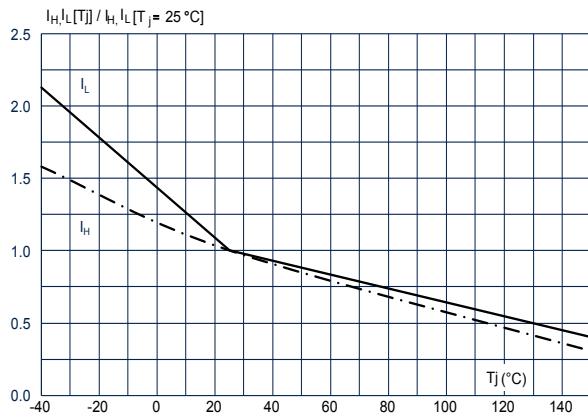


Figure 10. Relative variation of static dV/dt immunity versus junction temperature (typical values)

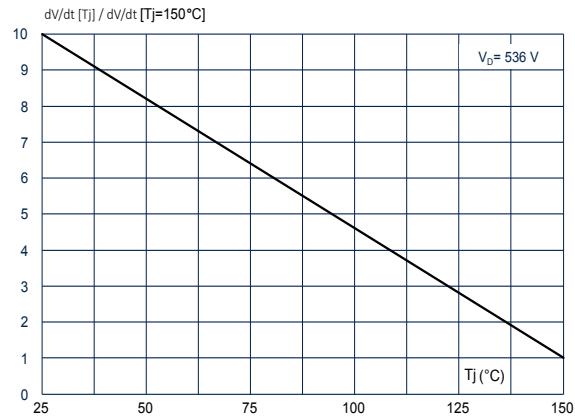
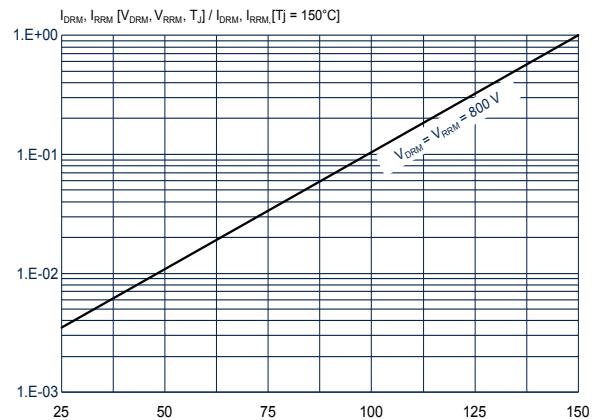


Figure 11. Relative variation of leakage current versus junction temperature for 800 V blocking voltage



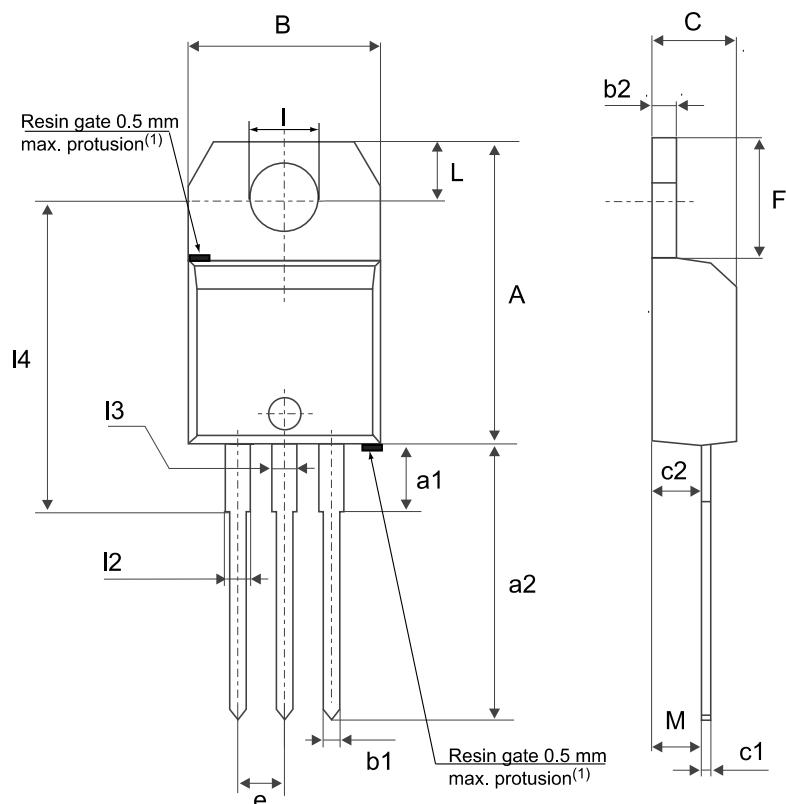
2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 TO-220AB package information

- Molding compound resin is halogen free and meets UL94 flammability standard, level V0
- Lead-free plating package leads
- Recommended torque: 0.4 to 0.6 N·m

Figure 12. TO-220AB package outline



(1)Resin gate position accepted in one of the two positions or in the symmetrical opposites.

Table 5. TO-220AB package mechanical data

Ref.	Dimensions					
	Millimeters			Inches ⁽¹⁾		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	15.20		15.90	0.5984		0.6260
a1		3.75			0.1476	
a2	13.00		14.00	0.5118		0.5512
B	10.00		10.40	0.3937		0.4094
b1	0.61		0.88	0.0240		0.0346
b2	1.23		1.32	0.0484		0.0520
C	4.40		4.60	0.1732		0.1811
c1	0.49		0.70	0.0193		0.0276
c2	2.40		2.72	0.0945		0.1071
e	2.40		2.70	0.0945		0.1063
F	6.20		6.60	0.2441		0.2598
I	3.73		3.88	0.1469		0.1528
L	2.65		2.95	0.1043		0.1161
l2	1.14		1.70	0.0449		0.0669
l3	1.14		1.70	0.0449		0.0669
l4	15.80	16.40	16.80	0.6220	0.6457	0.6614
M		2.6			0.1024	

1. Inch dimensions are for reference only.

3 Ordering information

Figure 13. Ordering information scheme

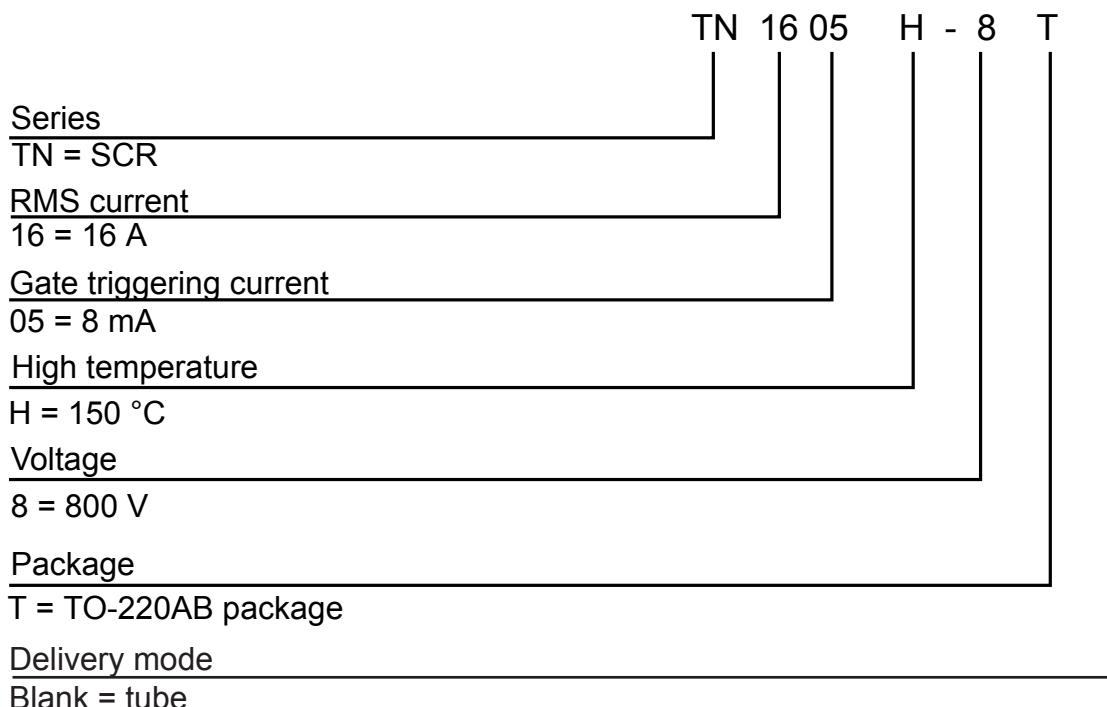


Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
TN1605H-8T	TN1605H8T	TO-220AB	2.3 g	50	Tube

Revision history

Table 7. Document revision history

Date	Revision	Changes
05-Dec-2022	1	Initial release.

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